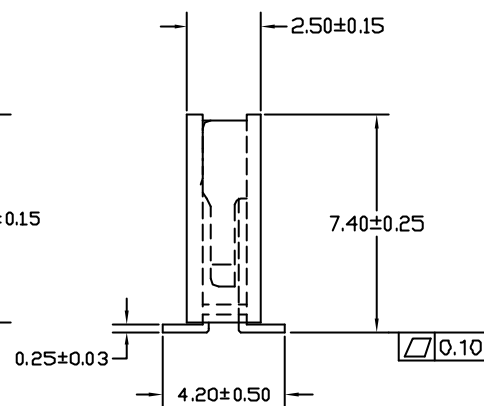
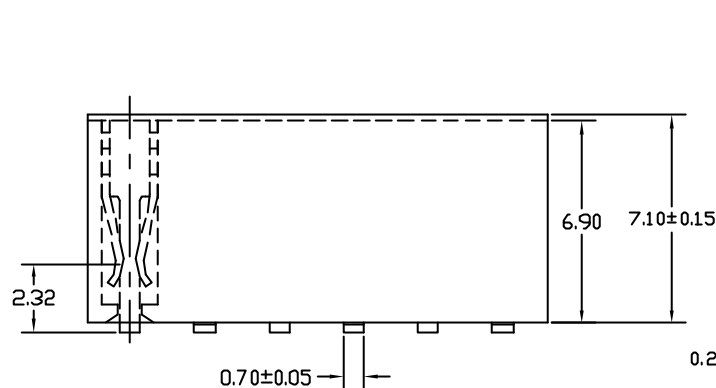
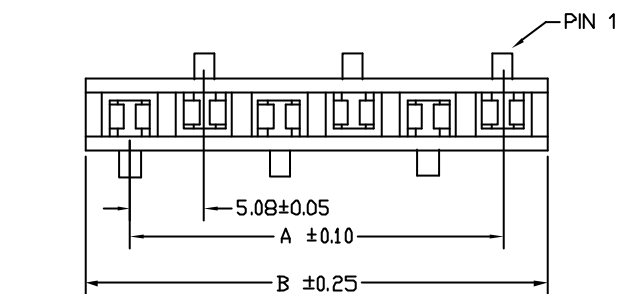
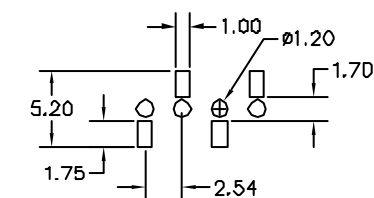


No. of Contacts	DIMENSIONS		REMARK (備註)
	A	B	
3	5.08	8.12	○
4	7.62	10.65	○
5	10.16	13.20	○
6	12.70	15.74	○
7	15.24	18.28	○
8	17.78	20.82	○
9	20.32	23.36	○
10	22.86	25.90	○
11	25.40	28.44	○
12	27.94	30.98	○
13	30.48	33.52	○
14	33.02	36.06	○
15	35.56	38.60	○
16	38.10	41.14	○
17	40.64	43.68	○
18	43.18	46.22	○
19	45.72	48.76	○
20	48.26	51.30	○
21	50.80	53.84	○
22	53.34	56.38	○
23	55.88	58.92	○
24	58.42	61.46	○
25	60.96	64.00	○
26	63.50	66.54	○
27	66.04	69.08	○
28	68.58	71.62	○
29	71.12	74.16	○
30	73.66	76.70	○
31	76.20	79.24	○
32	78.74	81.78	○
33	81.28	84.32	○
34	83.82	86.86	○
35	86.36	89.40	○
36	88.90	91.94	○
37	91.44	94.48	○
38	93.98	97.02	○
39	96.52	99.56	○
40	99.06	102.1	○



Recommended P.C.Board
SMD Layout



SPECIFICATIONS

Current Rating: 3 Amps
Insulator resistance: 5000 Megohms min.
Contact resistance: 20 m ohms max.
Dielectric withstanding: AC 1000 V
Operating Temperature: -40°~+105°C
Contact Material: Phosphor bronze
Insulator Material: High Temperature Thermoplastic,UL 94V-0

Finish: Tin,Gold or Duplex plated

◎Standard: Gold flash all over

◎Note:

Duplex plating: gold plated on contact area,
Tin on solder area

MORETHANALL
CONNECTORS
ASSEMBLIES

PART NO. **F-274X-1XxxL**

DWG NO. **F-274X-1XxxL**

FILE NO.

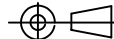
UNIT / mm

SCALE 1:1

CHECKED BY CY

DRAWING BY

PROJECTION



TOLERANCES ARE

.X ±
.XX ±
.XXX ±
AWG

DESCRIP TION:

AREA

REVISIONS

HK

DATE

煜倫有限公司